Admission ticket and program

IRELESS JAPAN

EXPO COMM WIRELESS JAPAN 2007

July 18-20,2007 Tokyo Big Sight, Tokyo, Japan 10:00am to 5:30pm - Final day closes at 5:00pm





Contents Creation & Delivery Networking Technology EXPO 2007



Wireless Broadband network and value added terminal create new wireless industry.

Exhibit Scope 2007

The cutting edge of wireless broadband technology and service will come together at EXPO COMM Wireless Japan. Market Wireless Broadband and intelligent terminal progress in Japan's wireless market.

Take this chance to explore the latest wireless solutions and develop new business partnerships at EXPO COMM Wireless Japan.



Wireless Broadband

This event introduces not only HADPA, CDMA2000 1x EV-CD Rev.A, WiMAX, Next Generation PHS, but also ZigBee, Wireless USB, UWB, Wi-Fi, etc.
You can find all the latest technology at EXPO COMM Wireless Japan 2007.

Keyword 3

Various Contents Services

SNS, Blog, Music delivery, visual delivery, etc.
You can explore the latest trends and
business solutions toward
"Mobile 2.0 world"

Keyword 2

Intelligent Mobile Terminal

Mobile Phones, PHS, Smart Phone/PDA, Wireless LAN & Mobile Dual Terminals, one segment broadcasting, etc. Several value added Mobile Terminals will be presented here sure to influence the daily life and business scene.

Keyword 4

The Latest Embedded Technology

Trends of semiconductor impact in the mobile and wireless market Furthermore, you will find the latest trends of a middleware application.











Registration

Pre-Registration is not required for people from overseas.

If you bring your business card on the day of the Expo, admission will be waived.

Official Site

http://www.wjexpo.com

Guide to the SPECIAL EXHIBITION on Wireless & **Mobile Technology and Services.**

Mobile computing technology keeps on developing in areas such as communication, visualimusic players, search engines, on-line payment, games and more. In the meantime, wireless technology and service for WAN, MAN, PAN are studied with high interest. In the EXPO COMM Wireless Japan 2007 Exhibition and conference you will find cutting edge technologies including mobile terminal, WiMAX, Wi-Fi, ZigBee, UWB, HSDPA, CDMA2000 1x EV-DC Rev.A and many others.

Products category in Expo Comm Wireless Japan 2007

- HSDPA / CDMA2000 1x EV-DC Rev.A / IEEE802.11 / WiMAX / Next Generation PHS / ZigBee / UWB / Bluetooth etc...
- Embedded device and software for wireless and mobile products
- Network measurement
- Content delivery platform
- Mobile commerce
- Security, authentication
- Application, content
- Wireless and mobile service
- Enterprise solution
- Mobile Terminal, PHS and smart phone etc...



Exhibitor list As of 12.June.2007

- ABIT Corporation
- Actix Ltd.
- Airpoint Co.,Ltd
- Andrew Corp.Antenova Ltd.
- Artiza Networks, Inc.
- BN TECHNOLOGY CORPORATION
- Broadcom Corporation

- C&S Technology Inc.Colubrisu Networks Japan K.K.
- Computer Graphic Arts Society
 CONTEC CO., LTD.
- Cornes Dodwell Ltd
- Crossbow Japan Ltd. DEMPA TIMES. CO., LTD.
- DENSO TOKYO CORPORATION
- Diamond-Friedman Co., Ltd.
- E2 Publishing Corp.
- ecash corporationEizo Shimbun Inc.
- EMOBILE Ltd.
- FA SYSTEM ENGINEERING CO.,LTD
- FOCUS Enhancements Japan K.K.
- Global IP Solutions, Inc
- Hamamatsu Photonics K.K
- himico Solutions, Inc.Hitachi Plant Technologies, Ltd.
- HTC Nippon Corporation
- Huawei Technologies Co..Ltd.

- iAnywhere Solutions, K.K. IBS Japan Co.,Ltd.

- Icera Inc.
 idaqs co,.ltd./NALLATECH
- Incom Co., Ltd.
- Industry-Academia-Government of YOKOSUKA CITY ITS 21
- Keihin Electric Express Railway Co.,Ltd. The University of Electro-Communications The University of Tokyo
- We Are Engineering Inc. Yokosuka City
- Infineon Technologies Japan K.K.
 Inter Solution Marketing Inc.
- IRI Commerce and Technology, Inc. ■ ITmedia Inc.

- KITAMURA MANUFACTRING CO., LTD. ■ Koden Electronics Co., Ltd.
- Lightwell Co., LTd.
- Medical Electronic Science Institute Co., Ltd.
 Meritech Co., Ltd.
 Microwave Absorbers Inc.

- MITSUBISHI ELECTRIC ENGINEERING CO.,LTD.
- Mobikyo K.K.
- MORITO Co., LTD
- Nagano Japan Radio Co.,LtdNEC Corp.
- NEC Engineering, Ltd.
- Nihon Openwane Systems K.K.

- Nihon Sonus Networks K.K. ■ Nikkei Business Publication,Inc.
- Noise Out CompanyNordic Semiconductor ASA/Germin
- NTT DoCoMo, Inc.
- Oki Electric Industry Co.,Ltd.
 Panasonic Mobile Communications Co.,Ltd.
- Qimonda Japan K.K.QUALCOMM Inc.
- RAILWAY INFORMATION SYSTEMS CO., LTD.
- Red Bend Software Japan K.K. RedDot Wireless Inc./NICCHO ELECTRONICS
- Corp./TOMUKI Corp./MICROTEK Inc.

 Reed Business Information Japan K.K.
- REPIC Corp./HUBER+SUHNER AG RIC TELECOM Co., Ltd.

- Ryoden Trading Co., Ltd./Integration Associates, Inc.
 SHARP Corp.
 Skyley Networks, Inc./Uniband Electronic
- Corporation (UBEC)

 Soliton Systems K.K.
- Sony Ericsson Mobile Communications Japan, Inc.
 Sophia Mobile, Ltd./Sophia Research Institute,
- Spansion Japan Ltd.
- Spectec Computer Co.,Ltd
- Star Game's Corp.
 SUSUMU CO.,LTD
- TATA Consultancy Services Japan Limited Tekenetworks, Ltd
- Tektronix Japan,Ltd. Telecom Engineering Center
- Texas Instruments Japan Ltd.
- TIVR Communications Pvt Ltd

- TOKIMEC INC.
- TOSHIBA Corp./Toshiba Solutions Corp./Toshiba Matsushita Display Technology Co., Ltd
- TOYO Corporation
- Trolltech UAT CORPORATION
- UbiNavi Co., Ltd.
- UNIADEX, Ltd.WILLCOM, Inc. Wireless Technologies, Inc./Bluenext Japan Ltd.
- Wisair Ltd.
- YOKOYAMA CO.LTD
- YRP R&D Promotion Committee ZERO SUM,LTD
- ZigBee Alliance / ZigBee SIG Japan Ad-Sol Nissin Corp
- Atmel Japan K.K
- Digi International K.K. Ember Corporation
- Freescale Semiconductor Japan Ltd.
- Hitachi, Ltd., WirelessInfo Venture Company/Hitachi, Ltd., Systems Development
- Laboratory/Technology Alliance Group, Inc. IMI Japan
- Jennic Ltd NEC Engineering, Ltd.
- Oki Electric Industry Co.,Ltd.
- OS Technology, Inc. RadioPulse Inc.
- Renesas Technology Corp. Texas Instruments Japan Ltd. TÜV Rheinland Japan Ltd.

Organizer: RIC TELECOM Co., Ltd. / EJK Japan, Ltd.

Endorse By: Ministry of Internal Affairs and Communications / The ITU Association of Japan Inc. / Association of Radio Industries & Business / Telecommunications Carriers Association / Internet Association Japan / YRP R&D Promotion Committee / ASP Industry Consortium Japan / NPO Japan Network Security Association / Next Generation Electronics Commerce Promotion Council of Japan (ECOM) / Digital Content Association of Japan / Japan Internet Providers Association / Japan Automatic Identification Systems Association / The Institute of Administrative Information Systems / The association for Promotion of Digital Broadcasting / Support Center for Advanced Telecommunications Technology Research / Communications and Information Network Association of Japan (CIAJ)

Supported By: Mobile Content Forum (MCF) / Mobile Computing Promotion Consortium (MCPC) / ITS Japan / Internet ITS Consortium / Korea Culture & Content Agency / ZigBee Alliance ZigBee SIG-J

official site: www.orga-techno.com

ORGATECHNO 2007

Ultimate ORGATECHNO "Computer controlled by thought"

ORGATECHNO 2007 introduces ongoing neo-futuristic frontier technologies called ultimate ORGATECHNO that link device and living being (i.e. cell phone with transfers emotion), and

ORGATECHNO that link device and living being (i.e. cell phone with transfers emotion), and also presents information processing/telecommunication.

New age will dawn carried by technology; for example, people enjoy computer games just by thinking in their mind without touching computer.

Conference zone gives you glimpse into the future gathering various technologies such as nanotechnology, biotechnology and of course information technology.

Exhibition and business seminar zone will give you a hint for the research and development on organic/bio- materials beyond the past concept.

Don't miss the chance to see a challenge of ORGATECHNO.



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WIRELESS CONFERENCE 2007

At the conference, key representatives from telecommunication carriers as well as major mobile manufacturers from both domestic and overseas markets will be presenting. EXPO COMM WIRELESS JAPAN provides a diverse conference program covering various topics including Next Generation Wireless, 4G and Next Generation Network, and Mobile Devices.

As of 12.June.2007

Λ	course	Mobi	le/Wirele	ess Telecom	municati	ons Busii	ness Strategy	Available in Japanese only
A		Venue	Reception Hall B	Seminer ticket price	31,500JPYen - on	e day pass - Re	gistration We accept ticket purch	ase on site by JPYen only
18	A-0	9:50-10:00	Welcome Addr	ess		Ministry of Internal A Communication, Japa		
(WED)	A-1	10:00-10:45	『DoCoMo2.0』	Future Evolution and C	hallenge-	NTT DoCoMo, Inc.	President and CEO	Masao Nakamura
	A-2	10:55-11:40		arket Leaders of FMC P of Ubiquitous Solution		KDDI CORPORATION	President and Chairman	Tadashi Onodera
	A-3	11:50-12:35						
	A-4	12:45-13:30		bile and Fixed」Convergence to COM presents opened and only		WILLCOM, Inc.	President	Masaki Kikugawa
	A-5	14:00-14:45	Revolution of EN	IMobile Broadband : Broad	dband is Mobiled	EMOBILE Ltd.	Founder, Chairman & CEO	Dr. Sachio Senmoto
	A-6	14:55-15:40		nmunication Service cre Mobile Broadband	eates	ACCA Networks Co.,L	Ltd. President and Representative Director	Yoshio Sakata
	A-7	15:50-16:35	WiMAX change	s Japan's Mobile Broad	band	YOZAN Inc.	Chairman	Sunao Takatori
	A-8	16:45-17:30	Mobile phones	of SHARP from now to	the future	SHARP CORPORATIO	N Product Business; Information and Communication Systems Business	Masafumi Matsumoto

D)	Next	Generatio	on Wireless Ted	hnology	and Mobile D	evelopment in Too	days Market.
D	course	Venue	Reception Hall B	Seminer ticket price	Free Registra	tion no necessaryly		
19	B-1	10:00-10:45			Available in English	Broadcom Corporation	Vice President, Research & Development	Edward H. Frank, PhD.
(THU)	B-2	10:55-11:40	OPEN WiMAX f Emerging Econ	or both Developed and omics	Available in English	Alvarion Ltd.	Corp. Vice President Strategy, Alvarion Ltd. Vice President Marketing, WiMAX Forum Chair: Marketing Working Group	Mohammad S. Shakouri
	B-3	11:50-12:35	Promote All-IP	in Wireless Strategy	Available in English	Sonus Networks, Inc.	Chairman & CEO	Hassan Ahmed
	B-4	13:00-13:45	Making Wirele and Personal	ss Global, Affordable	Available in English	Texas Instruments Incorporated	Senior Vice President and general manager of Wireless Terminal Business Unit	Greg Delagi
	B-5	13:55-14:40	Business Strate Future of Mobi	egy of Qualcomm, Looking ile Broadband	g ahead to	QUALCOMM JAPAN Inc.	President	Jun Yamada
	B-6	14:50-15:35				HTC Nippon		
	B-7	15:45-16:30	Sony Ericsson (designs User Experience		Sony Ericsson Mobile Communications Japan, Inc.	President and Representative Director	Yukio Kubota

C		IEEE8	l	Available in Japanese only		
6	course	Venue	Room#102 Seminer ticket price 31,500JPYen - one day	pass - Registration W	e accept ticket purchase on sit	e by JPYen only.
18	C-1	10:00-10:50	IEEE802 Wireless Technology Leading Edge Trend	Chiba University, Graduate School of Advanced	Integration Science, Ubiquitous Communication and Networking	Shirou Sakata
(WED)	C-2	11:00-11:50	IEEE802.11n standardization update and discussion of its market deployment.	Qualcomm, CDMA Technologies	Sr. Director of Technical Marketing	Eiji Takagi
	C-3	12:00-12:50	Expanding Wireless LAN: IEEE802.11 roadmap and the reorganization of 5GHz band	Atheros Communications, K.K.	Sr. Director of Strategic Marketing, Officer	Dr. Tomoki Ohsawa
	C-4	14:00-14:50		NEC	Central Research Labratories, System Platform Research Labratories.	Shinichi Morimoto
	C-5	15:00-15:50	IEEE802.16e (Mobile WiMAX) the newest trend	KDDI CORPORATION	Head of Wireless Broadband System Development Section Technology Strategy Department, Network Engineering Division	Toshikazu Yokai
	C-6	16:00-16:50	Mesh Routing (IEEE802.11s) Trend	Thinktube Inc.,	President	Takayuki Kaiso
	C-7	17:00-17:50		NEC	ITS Business Development Center Expert	Takeshi Yamamoto

n	4G 8	Next Generation Network	Available in Japanese only		
U	course Venue	Room#102 Seminer ticket price 31,500JPYen - one of	day pass - Registration	We accept ticket purchase on si	te by JPYen only.
9	D-1 10:00-10:50	Mobile Telecommunication System Future Trend -from 3G to IMT-Advanced-	Nippon Ericsson	Vice President & Chief Technology Officer	Masanobu Fujioka
THU)	D-2 11:00-11:50	Development Structure and Trial Efforts toward NTT DoCoMo 4G -Super3G and IMT-Advanced-	NTT DoCoMo, Inc.	Vice President managing Director of Radio Access Network Development Department	Seizo Onoe
	D-3 12:00-12:50	Reality and future trend of CDMA2000 technology	KDDI CORPORATION	Technical Standards and Spectrum Division, Industry Relation Department Standard Strategy Section	Tomoyuki Tamura
	D-4 14:00-14:50	Next Generation PHS generates development trend and future trend	WILLCOM, Inc.	Development Department Manager	Hiroshi Kawai
	D-5 15:00-15:50	IEEE802.20 Standardization Updates and Technical Overview	V QUALCOMM JAPAN Inc.	Engineer, Staff/Manager	Kazuhito Ishida
	D-6 _{16:00-16:50}	IEEE802.21 generated trend and detail. Future Trend	National Institute of Information and Communications Technology New Ger Wireless Communications Research Ce	neration enter	Masahiro Kuroda
	D-7 17:00-17:50	What is UMB? -Full Picture of Next Generation Mobile Broadband Technology-	QUALCOMM JAPAN Inc.	Business Development / Director	Hiroyuki Kawabata

Е		Blue]	Available in Japanese only			
	course	Venue	Seminer Room by East Hall 3 Entrance	Seminer ticket price Fre	e Registration	no necessaryly	
18		10:10-10:50	Introduction to Bluetooth SIG and t technology update	he latest Bluetoc	th SIG, Inc.	Technical Marketing Manager, Japan	Takaharu Hompo
(WED)	E-2	11:00-11:40	Bluetooth Technology Road Map	CSR, Lt	l. (Japan)	Chief Engineer	Sohju Tominaga
	E-3	11:50-12:30	RF performance test of Bluetooth D	evice Anritsu	Corporation	Microwave Measurement DivEurope Product Marketing Engineer	Hiroshi Fukumoto
	E-4	12:40-13:20					

С		ZigBee Forum					
	course	Venue	Seminer Room by East Hall 3 Entrance	eminer ticket pric	e Free Registration	no necessaryly	
19	F-1	10:30-10:55	Greeting: ZigBee Forum	Available in Japanese only	ZigBee SIG Japan	Chairman	Koichi Sakanashi
(THU)	F-2	11:00-11:40	Wireless Sensors and Control Network Enabling New Opportunities	Available in English	ZigBee Alliance	Chairman	Bob Heile
	F-3	11:45-12:25	The ZigBee Technical Overview	Available in English	Texas Instruments	Software - Low Power Wireless Technical Director	Don Sturek
	F-4	12:30-13:10	ZigBee Foundations, an introduction to the ZigBee Network and Security	Available in English	Integration Associates	Engineer	lan Marsden
	F-5	13:15-13:55	ZigBee Product Certification / ZigBee Product Testing	Available III	Daintree Networks TÜV Rheinland of North America	President International Transmitter Program Manager	Bill Wood John Lin
	F-6	14:00-14:40	ZigBee for Energy Management and Efficiency	Available in English	ZigBee Alliance	Vice President of Marketing	Brent Hodges
	F-7	14:45-15:10	Case Study: ZigBee Systems for environments monitoring in historic buildings	Available in Japanese only	Jennic Ltd	Senior Field Application Engineer	Takatoshi Kitajima
	F-8	15:15-15:40		Available in English	Radio Pulse	Korea Global Sales & Marketing	Andy Eom
	F-9	15:45-16:10	Wireless sensor network platform by NEC Engineering	Available in Japanese only	NEC Engineering, Ltd.	Manager Market Planning Department Sales & Marketing Division	Kazumasa Saito
	F-10	16:15-16:40	Business Strategy of Sensor Networks	Available in Japanese only	Oki Electric Industry Co.,Ltd.	Sensor Network Venture Unit SE Manager	Kenichi Imaizumi
	F-11	16:45-17:15	ZigBee Total Solution supported by Renesas	Available in Japanese only	Renesas Solutions Corp.	Department Manager Application Engineering Department 3 Application Engineering Division 1	Takashi Furumura



Workshop

P/18 (TUE) • Q/20 (FRI)